

STGP10NB60S

N-CHANNEL 10A - 600V TO-220 PowerMESHTM IGBT

TYPE	V _{CES}	V _{CE(sat)}	I _C
STGP10NB60S	600 V	< 1.7 V	10 A

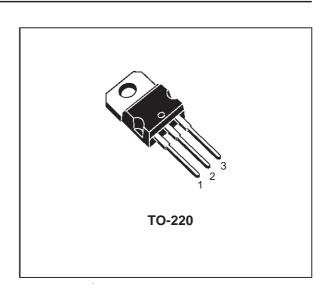
- HIGH INPUT IMPEDANCE (VOLTAGE DRIVEN)
- VERY LOW ON-VOLTAGE DROP (Vcesat)
- HIGH CURRENT CAPABILITY
- OFF LOSSES INCLUDE TAIL CURRENT

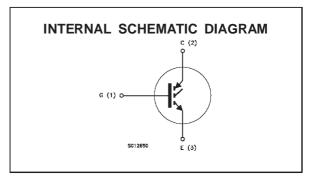
DESCRIPTION

Using the latest high voltage technology based on a patented strip layout, STMicroelectronics has designed an advanced family of IGBTs, the PowerMESHTM IGBTs, with outstanding perfomances. The suffix "S" identifies a family optimized to achieve minimum on-voltage drop for low frequency applications (<1kHz).

APPLICATIONS

- LIGHT DIMMER
- STATIC RELAYS
- MOTOR CONTROL





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit
V _{CES}	Collector-Emitter Voltage (V _{GS} = 0)	600	V
V _{ECR}	Reverse Battery Protection	20	V
V_{GE}	Gate-Emitter Voltage	± 20	V
Ic	Collector Current (continuous) at T _c = 25 °C	20	А
Ic	Collector Current (continuous) at T _c = 100 °C	10	А
I _{CM} (•)	Collector Current (pulsed)	80	А
P_{tot}	Total Dissipation at T _c = 25 °C	80	W
	Derating Factor	0.64	W/°C
T _{stg}	Storage Temperature	-65 to 150	°C
Tj	Max. Operating Junction Temperature	150	°C

(•) Pulse width limited by safe operating area

June 1999 1/8

THERMAL DATA

R _{thj-case}	Thermal	Resistance	Junction-case	Max	1.56	°C/W
R _{thj-amb}	Thermal	Resistance	Junction-ambient	Max	62.5	°C/W
R _{thc-sink}	Thermal	Resistance	Case-sink	Тур	0.2	°C/W

ELECTRICAL CHARACTERISTICS ($T_j = 25$ °C unless otherwise specified)

OFF

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{BR(CES)}	Collector-Emitter Breakdown Voltage	$I_C = 250 \ \mu A$ $V_{GE} = 0$	600			V
V _{BR(ECR)}	Emitter-Collector Breakdown Voltage	IC = 1 mA V _{GE} = 0	20			V
I _{CES}	Collector cut-off (V _{GE} = 0)	$V_{CE} = Max Rating$ $T_j = 25 ^{\circ}C$ $V_{CE} = Max Rating$ $T_j = 125 ^{\circ}C$			10 100	μΑ μΑ
I _{GES}	Gate-Emitter Leakage Current (V _{CE} = 0)	$V_{GE} = \pm 20 \text{ V}$ $V_{CE} = 0$			± 100	nA

ON (*)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V _{GE(th)}	Gate Threshold Voltage	$V_{CE} = V_{GE}$ $I_C = 250 \mu A$	2.5		5	V
V _{CE(SAT)}		$V_{GE} = 15 \text{ V}$ $I_{C} = 5 \text{ A}$ $V_{GE} = 15 \text{ V}$ $I_{C} = 10 \text{ A}$ $V_{GE} = 15 \text{ V}$ $I_{C} = 10 \text{ A}$ $T_{j} = 125 ^{\circ}\text{C}$		1.15 1.35 1.25	1.7	< < <

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
g fs	Forward Transconductance	V _{CE} =25 V I _C = 10 A	5			S
C _{ies} C _{oes} C _{res}	Input Capacitance Output Capacitance Reverse Transfer Capacitance	$V_{CE} = 25 \text{ V}$ f = 1 MHz $V_{GE} = 0$		610 65 12	780 85 15	pF pF pF
Q _G	Gate Charge	$V_{CE} = 400 \text{ V}$ $I_{C} = 10 \text{ A}$ $V_{GE} = 15 \text{ V}$		33		nC
I _{CL}	Latching Current	$V_{clamp} = 480 \text{ V} RG=1k\Omega$ $T_j = 150 \text{ °C}$	20			А

SWITCHING ON

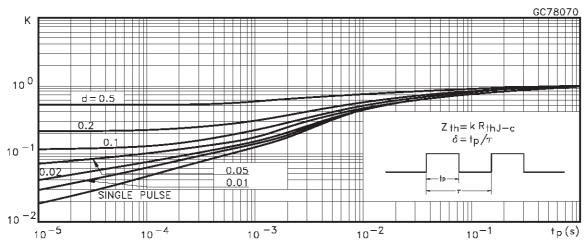
Symbol	Parameter	Test Condi	Min.	Тур.	Max.	Unit	
t _{d(on)}	Delay Time Rise Time	V _{CC} = 480 V V _{GE} = 15 V	$I_C = 10 A$ $R_G = 1 K\Omega$		0.7 0.46		μs μs
(di/dt) _{on}	Turn-on Current Slope	$V_{CC} = 480 \text{ V}$ $R_G = 1 \text{ K}\Omega$	I _C = 10 A V _{GE} = 15 V		8		A/μs
Eon	Turn-on Switching Losses	T _j = 125 °C	3 2		0.6		mJ

ELECTRICAL CHARACTERISTICS (continued)

SWITCHING OFF

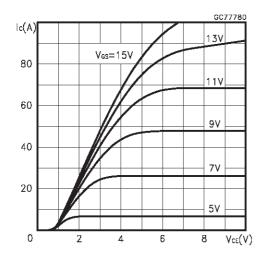
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
$\begin{array}{c} t_c \\ t_r(v_{off}) \\ t_f \\ E_{off}(^{**}) \end{array}$	Cross-Over Time Off Voltage Rise Time Fall Time Turn-off Switching Loss	$V_{CC} = 480 \text{ V}$ $I_{C} = 10 \text{ A}$ $V_{GE} = 15 \text{ V}$	1	2.2 1.2 1.2 5.0		μs μs μs mJ
$\begin{array}{c} t_{c} \\ t_{r}(v_{off}) \\ t_{f} \\ E_{off}(^{**}) \end{array}$	Cross-Over Time Off Voltage Rise Time Fall Time Turn-off Switching Loss	$V_{CC} = 480 \text{ V}$ $I_{C} = 10 \text{ A}$ $V_{GE} = 15 \text{ V}$ $I_{J} = 125 \text{ °C}$		3.8 1.2 1.9 8.0		μs μs μs mJ

Thermal Impedance

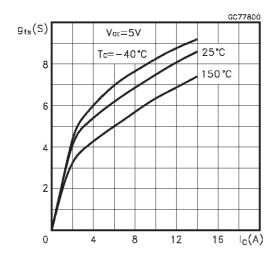


^(•) Pulse width limited by safe operating area
(*) Pulsed: Pulse duration = 300 μs, duty cycle 1.5 %
(**)Losses Include Also The Tail (Jedec Standardization)

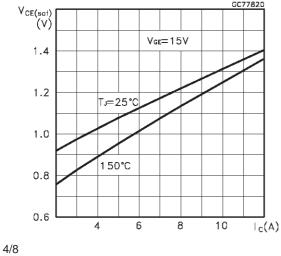
Output Characteristics



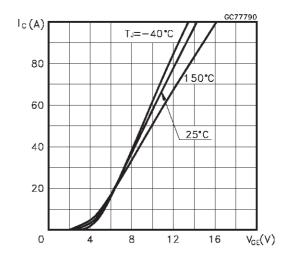
Transconductance



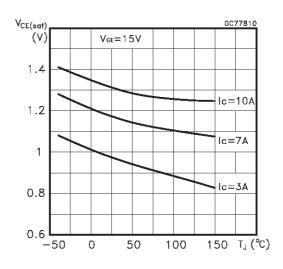
Collector-Emitter On Voltage vs Collector Current



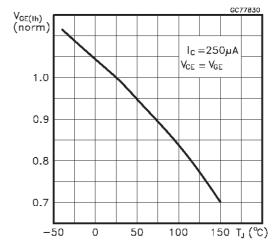
Transfer Characteristics



Collector-Emitter On Voltage vs Temperature

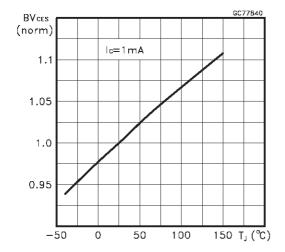


Gate Threshold vs Temperature

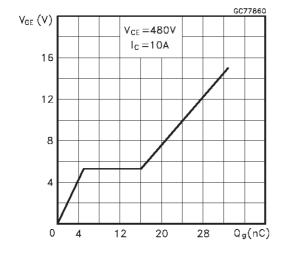


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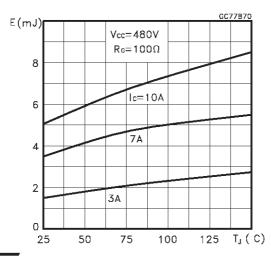
Normalized Breakdown Voltage vs Temperature



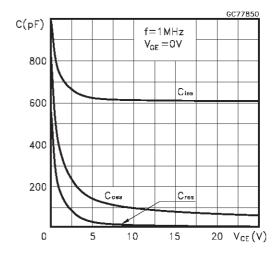
Gate Charge vs Gate-Emitter Voltage



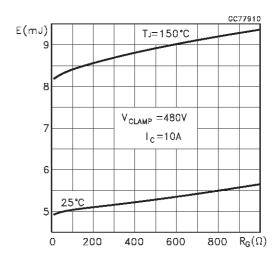
Off Losses vs Temperature



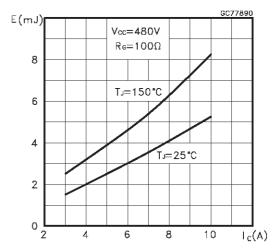
Capacitance Variations



Off Losses vs Gate Resistance



Off Losses vs Collector Current



Switching Off Safe Operatin Area

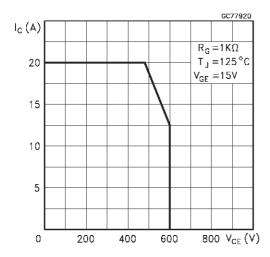


Fig. 1: Gate Charge test Circuit

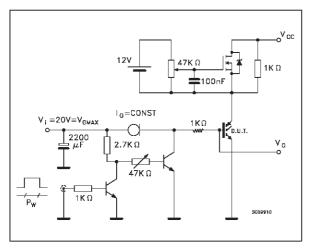


Fig. 2: Test Circuit For Inductive Load Switching

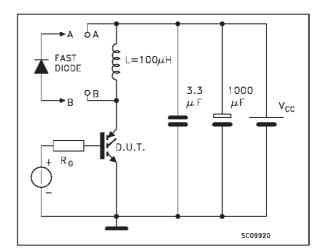
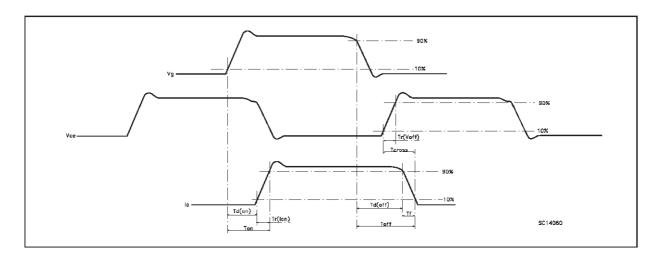
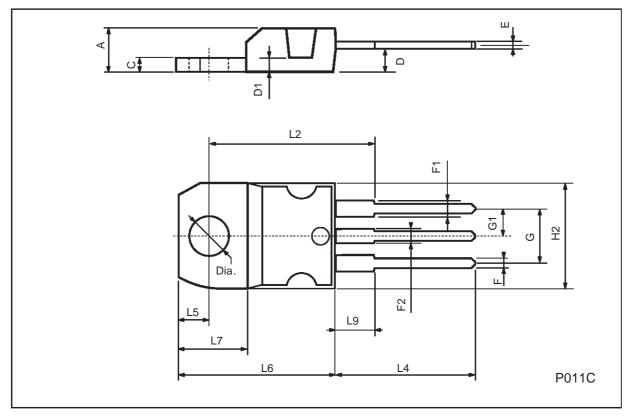


Fig. 3: Test Circuit For Inductive Load Switching



TO-220 MECHANICAL DATA

DIM.		mm			inch	
Dilvi.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.40		4.60	0.173		0.181
С	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



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